

## Schottky Rectifier, 2 x 15 A


**TO-220AB**


### FEATURES

- 150 °C  $T_J$  operation
- Very low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)



### PRODUCT SUMMARY

Package	TO-220AB
$I_{F(AV)}$	2 x 15 A
$V_R$	30 V
$V_F$ at $I_F$	0.37 V
$I_{RM}$ max.	350 mA at 125 °C
$T_J$ max.	150 °C
Diode variation	Common cathode
$E_{AS}$	15 mJ

### DESCRIPTION

This center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	30	A
$V_{RRM}$		30	V
$V_F$	15 $A_{pk}$ , $T_J = 125$ °C (per leg)	0.37	
$T_J$	Range	- 55 to 150	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-30L30CTPBF	VS-30L30CT-N3	UNITS
Maximum DC reverse voltage	$V_R$	30	30	V
Maximum working peak reverse voltage	$V_{RWM}$			

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	50 % duty cycle at $T_C = 140$ °C, rectangular waveform	30	A
			per device	
Maximum peak one cycle non-repetitive surge current	$I_{FSM}$	5 $\mu$ s sine or 3 $\mu$ s rect. pulse	1450	A
		10 ms sine or 6 ms rect. pulse	220	
Non-repetitive avalanche energy per leg	$E_{AS}$	$T_J = 25$ °C, $I_{AS} = 2$ A, $L = 7.5$ mH	15	mJ
Repetitive avalanche current per leg	$I_{AR}$	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	2	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop per leg	$V_{FM}^{(1)}$	15 A	$T_J = 25\text{ }^\circ\text{C}$	0.46	V
		30 A		0.57	
		15 A	$T_J = 125\text{ }^\circ\text{C}$	0.37	
		30 A		0.50	
Maximum reverse leakage current per leg	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_R$	1.50	mA
		$T_J = 125\text{ }^\circ\text{C}$		350	
Maximum junction capacitance per leg	$C_T$	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^\circ\text{C}$		1500	pF
Typical series inductance per leg	$L_S$	Measured lead to lead 5 mm from package body		8.0	nH
Maximum voltage rate of change	dV/dt	Rated $V_R$		10 000	V/ $\mu\text{s}$

Note

(1) Pulse width < 300  $\mu\text{s}$ , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$			- 55 to 150	$^\circ\text{C}$
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		1.5	$^\circ\text{C/W}$
Maximum thermal resistance, junction to case per package				0.8	
Approximate weight				2.0	g
				0.07	oz.
Mounting torque	minimum maximum			6 (5)	kgf · cm
				12 (10)	(lbf · in)
Marking device		Case style TO-220AB		30L30CT	

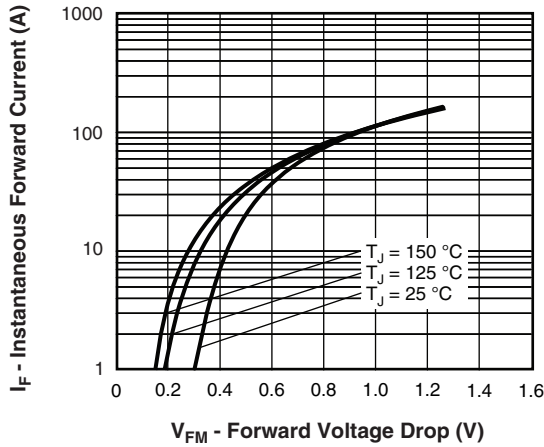


Fig. 1 - Maximum Forward Voltage Drop Characteristics

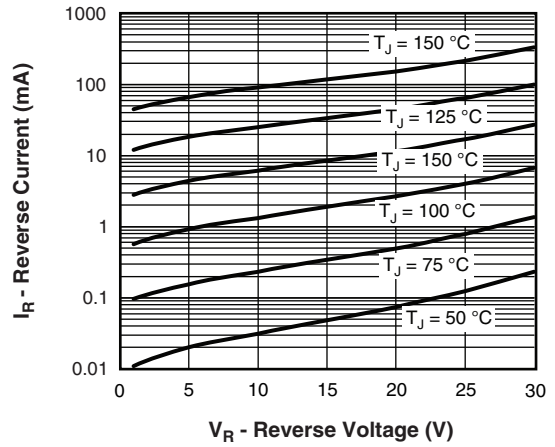


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

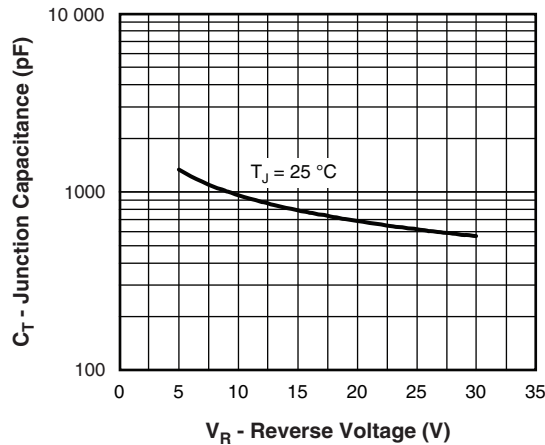


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

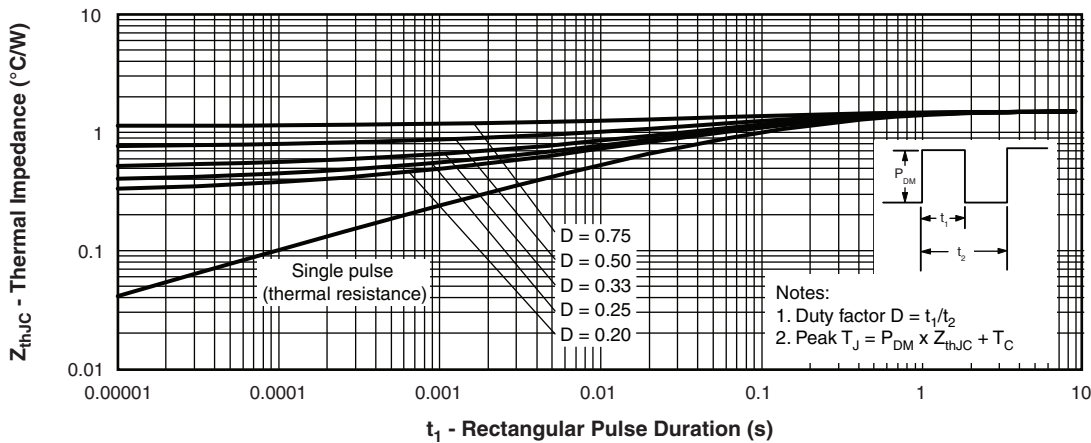


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

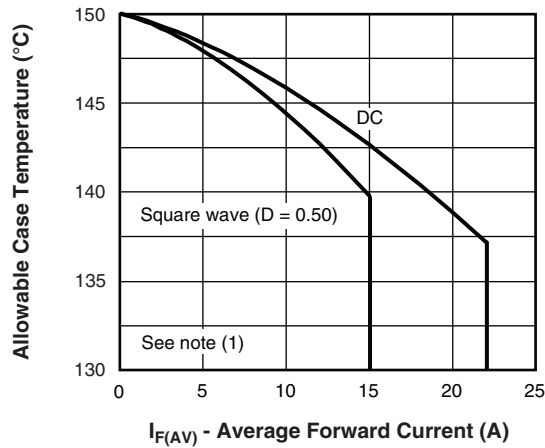


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

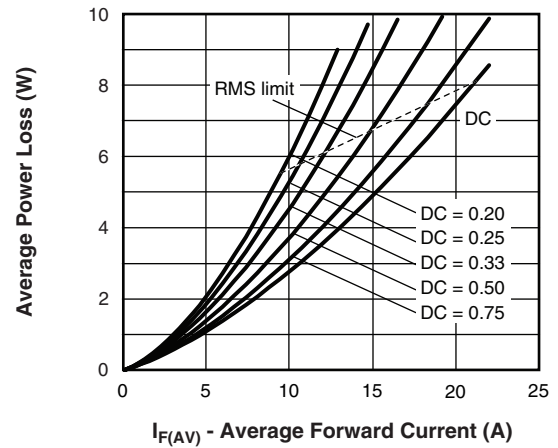


Fig. 6 - Forward Power Loss Characteristics

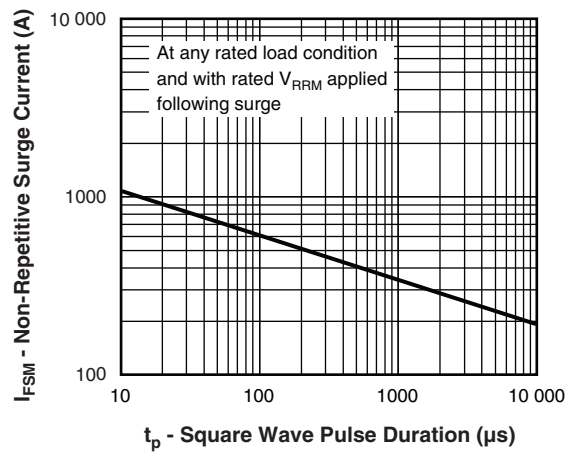


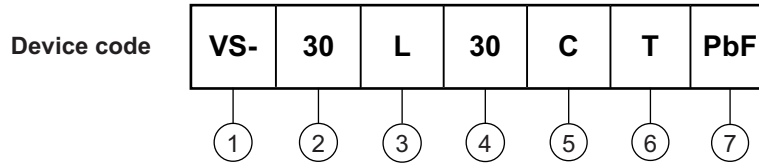
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

**Note**

(1) Formula used:  $T_C = T_J - P_d \times R_{thJC}$ ;  
 $P_d = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}$



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (30 = 30 A)
- 3** - Schottky "L" series
- 4** - Voltage rating (30 = 30 V)
- 5** - C = Common cathode
- 6** - Package:  
T = TO-220
- 7** - Environmental digit
  - PbF = Lead (Pb)-free and RoHS compliant
  - -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

<b>ORDERING INFORMATION</b> (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-30L30CTPbF	50	1000	Antistatic plastic tube
VS-30L30CT-N3	50	1000	Antistatic plastic tube

<b>LINKS TO RELATED DOCUMENTS</b>	
Dimensions	<a href="http://www.vishay.com/doc?95222">www.vishay.com/doc?95222</a>
Part marking information	TO-220AB PbF <a href="http://www.vishay.com/doc?95225">www.vishay.com/doc?95225</a>
	TO-220AB -N3 <a href="http://www.vishay.com/doc?95028">www.vishay.com/doc?95028</a>
SPIICE model	<a href="http://www.vishay.com/doc?95287">www.vishay.com/doc?95287</a>

## TO-220AB

**DIMENSIONS** in millimeters and inches



**Lead assignments**

Diodes

1. - Anode/open
2. - Cathode
3. - Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
e	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
Ø P	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° to 93°		90° to 93°		

**Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



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